

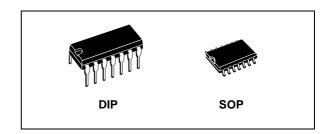


# DUAL COMPLEMENTARY PAIR PLUS INVERTER

- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- MEDIUM SPEED OPERATION  $t_{PD} = 30$ ns (Typ.) AT 10V
- QUIESCENT CURRENT SPECIFIED UP TO 20V
- 5V, 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT I<sub>I</sub> = 100nA (MAX) AT V<sub>DD</sub> = 18V T<sub>A</sub> = 25°C
- 100% TESTED FOR QUIESCENT CURRENT



The HCF4007UB is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor technology available in DIP and SOP packages. The HCF4007UB type is comprised of three n-channel and three p-channel enhancement type MOS transistors. The transistor elements are accessible through the package terminals to provide a convenient means for constructing the various typical circuits as shown in typical

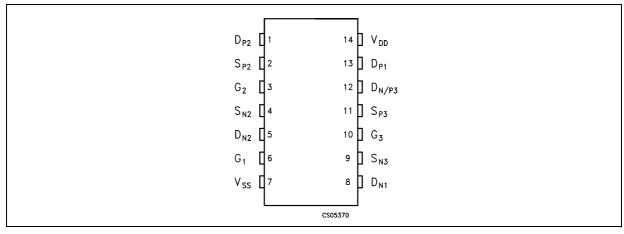


#### **ORDER CODES**

PACKAGE	TUBE	T&R
DIP	HCF4007UBEY	
SOP	HCF4007UBM1	HCF4007UM013TR

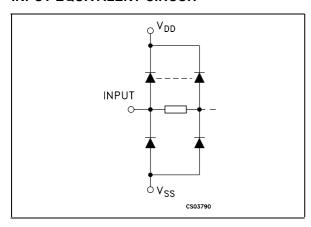
applications. More complex functions are possible using multiple packages. Number shown in parentheses indicate terminals that are connected together to form the various configuration listed.

#### **PIN CONNECTION**

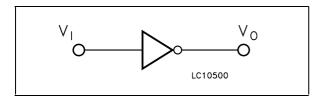


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### **INPUT EQUIVALENT CIRCUIT**



#### **LOGIC DIAGRAM**



### **PIN DESCRIPTION**

PIN N°	SYMBOL	NAME AND FUNCTION
2, 11	S <sub>P2</sub> , S <sub>P3</sub>	Source Connections to 2nd and 3rd p-channel transistors
13, 1	D <sub>P1</sub> , D <sub>P2</sub>	Drain Connections from the 1st and 2nd p-channel transistors
8, 5	D <sub>N1</sub> , D <sub>N2</sub>	Drain Connections from the 1st and 2nd n-channel transistors
4, 9	S <sub>N2</sub> , S <sub>N3</sub>	Source Connections to the 2nd and 3rd n-channel
12	D <sub>N/P3</sub>	Common connection to the 3rd p-channel and n-channel transistor drains
6, 3, 10	G <sub>1</sub> to G <sub>3</sub>	Gate connections to n-channel and p-channel of the three transistor pairs
7	V <sub>SS</sub>	Negative Supply Voltage
14	$V_{DD}$	Positive Supply Voltage

# **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	-0.5 to +22	V
V <sub>I</sub>	DC Input Voltage	-0.5 to V <sub>DD</sub> + 0.5	V
I <sub>I</sub>	DC Input Current	± 10	mA
P <sub>D</sub>	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
T <sub>op</sub>	Operating Temperature	-55 to +125	°C
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to  $\ensuremath{V_{\text{SS}}}$  pin voltage.

# **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	3 to 20	V
V <sub>I</sub>	Input Voltage	0 to V <sub>DD</sub>	V
T <sub>op</sub>	Operating Temperature	-55 to 125	°C

# **DC SPECIFICATIONS**

			Test Con	dition		Value							
Symbol	Parameter	VI	v <sub>o</sub>	I <sub>O</sub>	V <sub>DD</sub>	Т	A = 25°	С	-40 to	85°C	-55 to	125°C	Unit
		(V)	(V)	<b>(μA)</b>	(μ <b>A</b> ) (V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
ΙL	Quiescent Current	0/5			5		0.01	0.25		7.5		7.5	
		0/10			10		0.01	0.5		15		15	μΑ
		0/15			15		0.01	1		30		30	μΑ
		0/20			20		0.02	5		150		150	
$V_{OH}$	High Level Output	0/5		<1	5	4.95			4.95		4.95		
	Voltage	0/10		<1	10	9.95			9.95		9.95		V
		0/15		<1	15	14.95			14.95		14.95		
V <sub>OL</sub> Low Level Output	5/0		<1	5		0.05			0.05		0.05		
	Voltage	10/0		<1	10		0.05			0.05		0.05	V
		15/0		<1	15		0.05			0.05		0.05	
$V_{IH}$	High Level Input		0.5/4.5	<1	5	4			4		4		
	Voltage		1/9	<1	10	8			8		8		V
			1.5/13.5	<1	15	12.5			12.5		12.5		
$V_{IL}$	Low Level Input		4.5/0.5	<1	5			1		1		1	
	Voltage		9/1	<1	10			2		2		2	V
			13.5/1.5	<1	15			2.5		2.5		2.5	
I <sub>OH</sub>	Output Drive	0/5	2.5	<1	5	-1.36	-3.2		-1.15		-1.1		
	Current	0/5	4.6	<1	5	-0.44	-1		-0.36		-0.36		mΑ
		0/10	9.5	<1	10	-1.1	-2.6		-0.9		-0.9		1117 \
		0/15	13.5	<1	15	-3.0	-6.8		-2.4		-2.4		
$I_{OL}$	Output Sink	0/5	0.4	<1	5	0.44	1		0.36		0.36		
	Current	0/10	0.5	<1	10	1.1	2.6		0.9		0.9		mΑ
		0/15	1.5	<1	15	3.0	6.8		2.4		2.4		
II	Input Leakage Current	0/18	Any In	put	18		±10 <sup>-5</sup>	±0.1		±1		±1	μΑ
CI	Input Capacitance		Any In	put			5	7.5					pF

The Noise Margin for both "1" and "0" level is: 1V min. with  $V_{DD}$ =5V, 2V min. with  $V_{DD}$ =10V, 2.5V min. with  $V_{DD}$ =15V

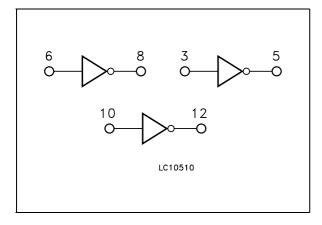
# $\textbf{DYNAMIC ELECTRICAL CHARACTERISTICS} \ (T_{amb} = 25 ^{\circ}C, \ C_{L} = 50 pF, \ R_{L} = 200 K\Omega, \ t_{f} = t_{f} = 20 \ ns)$

Symbol Parameter	Test Condition		Value (*)			Unit	
Symbol	Parameter	V <sub>DD</sub> (V)		Min.	Тур.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time	5			55	110	
		10			30	60	ns
		15			25	50	
t <sub>TLH</sub> t <sub>THL</sub>	Transition Time	5			100	200	
		10			50	100	ns
		15			40	80	

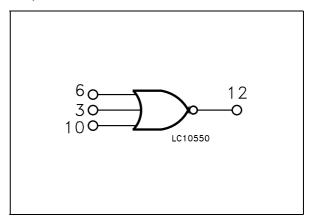
(\*) Typical temperature coefficient for all V<sub>DD</sub> value is 0.3%/°C.

### **TYPICAL APPLICATIONS**

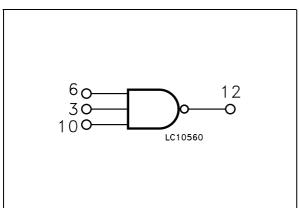
**TRIPLE INVERTERS:** (14, 2, 11); (8,13); (1, 5); (4, 7, 9)



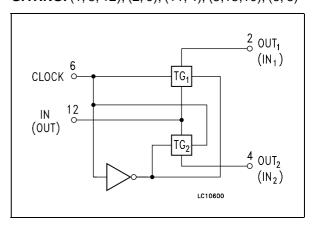
**3-INPUT NOR GATE**: (13, 2); (1, 11); (12, 5, 8); (4, 7, 9)



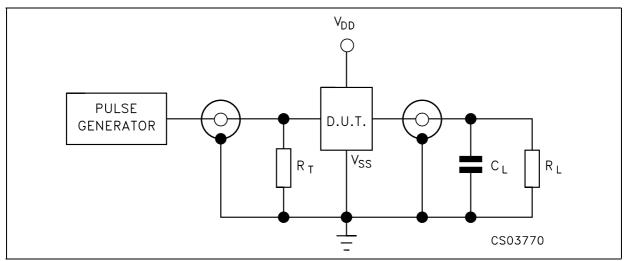
**3-INPUT NAND GATE:** (1, 12, 13); (2, 14, 11); (4, 8); (5, 9)



**DUAL BIDIRECTIONAL TRASMISSION GATING:** (1, 5, 12); (2, 9); (11, 4); (8,13,10); (6, 3)

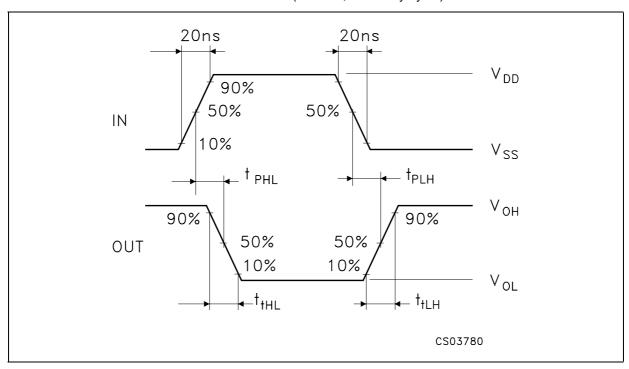


### **TEST CIRCUIT**



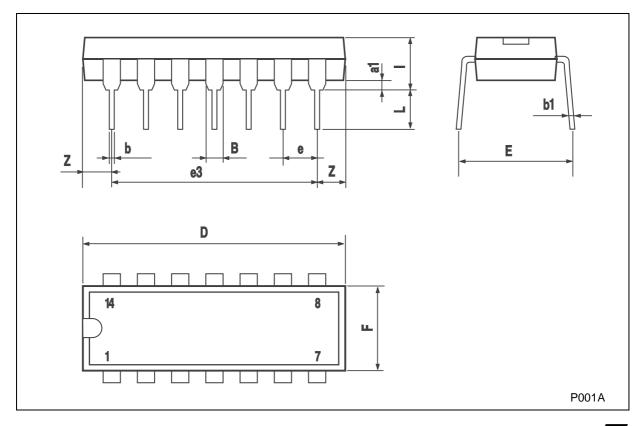
 $C_L$  = 50pF or equivalent (includes jig and probe capacitance)  $R_L$  = 200K $\Omega$   $R_T$  =  $Z_{OUT}$  of pulse generator (typically 50 $\Omega$ )

# WAVEFORM: PROPAGATION DELAY TIMES (f=1MHz; 50% duty cycle)



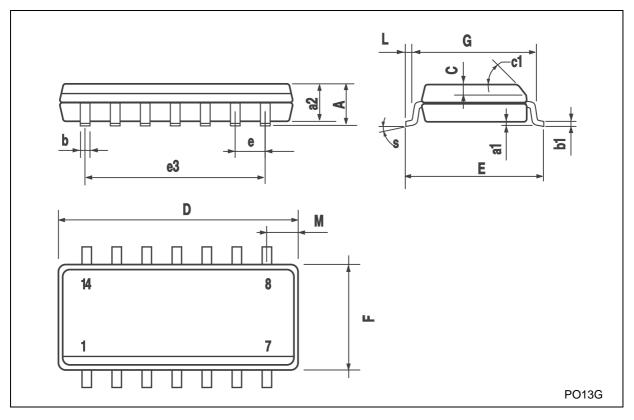
# **Plastic DIP-14 MECHANICAL DATA**

DIM		mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
a1	0.51			0.020			
В	1.39		1.65	0.055		0.065	
b		0.5			0.020		
b1		0.25			0.010		
D			20			0.787	
E		8.5			0.335		
е		2.54			0.100		
e3		15.24			0.600		
F			7.1			0.280	
I			5.1			0.201	
L		3.3			0.130		
Z	1.27		2.54	0.050		0.100	

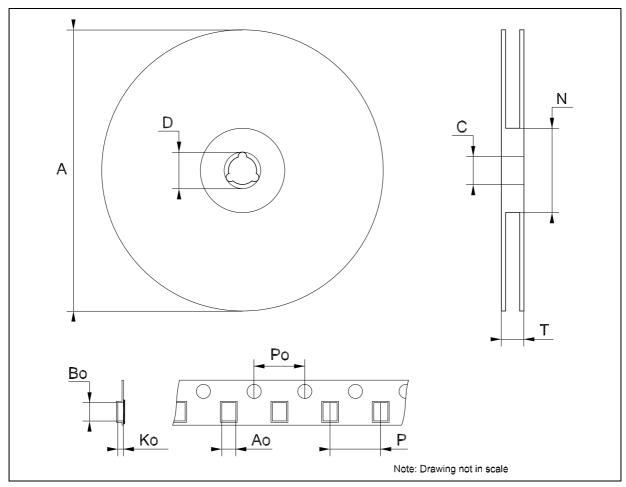


# **SO-14 MECHANICAL DATA**

DIM		mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
Α			1.75			0.068	
a1	0.1		0.2	0.003		0.007	
a2			1.65			0.064	
b	0.35		0.46	0.013		0.018	
b1	0.19		0.25	0.007		0.010	
С		0.5			0.019		
c1			45°	(typ.)			
D	8.55		8.75	0.336		0.344	
E	5.8		6.2	0.228		0.244	
е		1.27			0.050		
e3		7.62			0.300		
F	3.8		4.0	0.149		0.157	
G	4.6		5.3	0.181		0.208	
L	0.5		1.27	0.019		0.050	
М			0.68			0.026	
S		•	8° (r	max.)			



DIM		mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
А			330			12.992	
С	12.8		13.2	0.504		0.519	
D	20.2			0.795			
N	60			2.362			
Т			22.4			0.882	
Ao	6.4		6.6	0.252		0.260	
Во	9		9.2	0.354		0.362	
Ko	2.1		2.3	0.082		0.090	
Po	3.9		4.1	0.153		0.161	
Р	7.9		8.1	0.311		0.319	



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